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This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) this device may not cause harmful interference, and
- (2) this device must accept any interference received, including interference that may cause undesired operation.

CALIFORNIA, USA ONLY

The Lithium battery adopted on this motherboard contains Perchlorate, a toxic substance controlled in Perchlorate Best Management Practices (BMP) regulations passed by the California Legislature. When you discard the Lithium battery in California, USA, please follow the related regulations in advance.

"Perchlorate Material-special handling may apply, see www.dtsc.ca.gov/hazardouswaste/perchlorate"

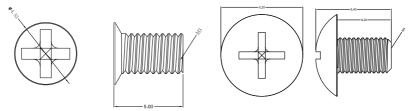
ASRock Industrial's Website: www.asrockind.com

Important Safety Instructions

For user safety, please read and follow all instructions, Warnings, Cautions, and Notes marked in this manual and on the associated device before handling/operating the device, to avoid injury or damage.

- 1. Read these safety instructions carefully.
- 2. Retain this user manual for future reference.
- Read the Specifications section of this manual for detailed information on the recommended operating environment.
- Disconnect the equipment from all AC outlets before cleaning. Use only a damp cloth for cleaning. Do not use liquid or sprayed detergent.
- Place the equipment on a reliable surface during installation. Dropping or letting the equipment fall may cause damage.
- 6. Do not leave the equipment in an environment with a storage temperature of below -40 °C (-40 °F) or above 85 °C (185 °F) as this may cause damage. The equipment should be stored in a controlled environment.
- 7. Ensure that the voltage of the power source is correct before connecting the equipment to a power outlet.
- 8. Position the power cord away from high-traffic areas. Do not place anything over the power cord.
- 9. If the equipment is not used for a long time, disconnect the equipment from the power source to avoid damage from transient over-voltage.
- 10. All cautions and warnings on the equipment should be noted.
- 1. To avoid electrical shock and/or damage to device:
 - Keep device away from water or liquid sources.
 - Keep device away from high heat or humidity.
 - Keep device properly ventilated (do not block or cover ventilation openings).
 - Always use recommended voltage and power source settings.
 - Always install and operate device near an easily accessible electrical outlet.
 - Secure the power cord (do not place any object on/over the power cord).
 - Only install/attach and operate device on stable surfaces and/or recommended mountings.
 - The power cord must be connected to a socket or outlet with a ground connection.
- 12. If one of the following occurs, have the equipment checked by service personnel:
 - The power cord or plug is damaged.
 - Liquid has penetrated into the equipment.
 - The equipment has been exposed to moisture.
 - The equipment is malfunctioning or does not operate according to the user manual.
 - The equipment has been dropped and damaged.

- The equipment shows obvious signs of breakage.
- 13. Never attempt to repair the device, which should only be serviced by qualified technical personnel using suitable tools.
- 14. Any unverified component may cause unexpected damage. To ensure correct installation, always use the components (e.g., screws) provided in the accessory box.
- This equipment is not suitable for use in locations where children are likely to be present.
- 16. The equipment should only be installed in a restricted access area.
- 17. Restricted Access Location: It is recommended that the device be installed only in a server room or computer room where access is:
 - Restricted to qualified service personnel or users familiar with restrictions applied to the location, reasons therefor, and any precautions required.
 - Only afforded by the use of a tool or lock and key, or other means of security, and controlled by the authority responsible for the location.
 - Be sure to turn off the power and then disconnect the power cords from your system before performing any installation or servicing. A sudden surge of power could damage sensitive electronic components.
 - All interior servicing is to be performed by qualified skilled personnel only, which requires the use of a tool for open the metal enclosure.



 $DIN\ Rail/Wall\ Mount: M3x5mm\ Screws\ (\textit{for securing the mounting bracket}(\textit{s})\ \textit{to the chassis})$

VESA Mount: M4x6mm Screws (for securing the VESA bracket to the monitor)

- 18. This model is intended to be supplied by an UL-certified power supply (Adapter: (1) FSP/FSP120-ABAN3, (2) FSP/FSP330-AAAN3) suitable for use at TMA 40 °C (104 °F) min., and the output is rated 19 Vdc 6.32A min., ES1. (For FSP120-ABAN3) / 24 Vdc 13.75A min., ES1 (For FSP330-AAAN). If you need further assistance, contact ASRock Industrial for additional information.
- 19. The terminal block is suitable for V+& V- for 14~28AWG. The torque value is 0.19Nm. Use copper conductors only. Kindly note that this must be installed by a skilled person.



20. This product has passed the CE environmental specifications test when shielded cables are used for external connections. To comply with emission limits, shielded interface cables must be used.

Replaceable batteries

CAUTION: RISK OF EXPLOSION IF BATTERY IS REPLACED BY AN INCORRECT TYPE. DISPOSE OF USED BATTERIES ACCORDING TO THE INSTRUCTIONS



BURN HAZARD

Hot surface! Do not touch! Touching this surface could result in bodily injury. To reduce risk, allow the surface to cool before touching.

CAUTION

The equipment is equipped with a battery-powered real-time clock circuit. There is a risk of explosion if a battery is incorrectly replaced. Replace only with same or equivalent type as recommended by the manufacturer. Discard all used batteries according to the manufacturer's instructions.

WARNING

All interconnection to the EUT is for indoor location and therefore PoE network interconnected to the EUT is considered as ES1/SELV for connected only to PoE network without routing to the outside plant.

WARNING

Input voltage rated 9-36V, 12.46-3.12A (For Basic SKU)

Input voltage rated 19-36V, 7.08-3.74A (For PoE SKU)

Input voltage rated 9-36V, 12.46-3.12A (For 5LAN SKU)

Input voltage rated 9-36V, 12.46-3.12A (For 5G SKU)

Input voltage rated 9-36V, 12.46-3.12A (For 8DIO SKU)

Packing: The unit should be carried with both hands and handled with care.

Maintenance: Use only approved products or a dry applicator to clean and maintain the surfaces.

Button Battery Safety Notice

- Remove and immediately recycle or dispose of used batteries according to local regulations and keep away from children. Do NOT dispose of batteries in household trash or incinerate.
- Even used batteries may cause severe injury or death.
- Call a local poison control center for treatment information.
- Battery type: CR2032
- Battery voltage: 3V
- Non-rechargeable batteries are not to be recharged.
- Do not force discharge, recharge, disassemble, heat above (manufacturer's specified temperature rating) or incinerate. Doing so may result in injury due to venting, leakage or explosion resulting in chemical burns.
- This product contains an irreplaceable battery.
- This icon indicates that a swallowed button battery can cause serious injury or death. Please keep batteries out of sight or reach of children.



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Contact Information

If you need to contact ASRock Industrial or want to know more about ASRock Industrial, you're welcome to visit ASRock Industrial's website at www.asrockind.com; or you may contact your dealer for further information.

ASRock Industrial Incorporation

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Chapter 1 Introduction



Because the hardware specifications might be updated, the content of this documentation will be subject to change without notice.

1.1 Package Contents

iEP-7040E-020 Series

- 1 x iEP-7040E-020
- 3 x Screws for M.2 Module
- 1 x Phoenix plug connector
- 1 x System QIG

iEP-7040E-021 Series

- 1 x iEP-7040E-021
- 2 x Screws for M.2 Module
- 1 x Phoenix plug connector
- · 1 x System QIG

iEP-7040E-022 Series

- 1 x iEP-7040E-022
- 2 x Screws for M.2 Module
- 1 x Phoenix plug connector
- 1 x System QIG

iEP-7040E-023 Series

- 1 x iEP-7040E-023
- 2 x Screws for M.2 Module
- 1 x Phoenix plug connector
- 1 x System QIG

iEP-7040E-024 Series

- 1 x iEP-7040E-024
- 3 x Screws for M.2 Module
- 1 x Phoenix plug connector
- 1 x System QIG

iEP-7040E-025 Series

- 1 x iEP-7040E-025
- 3 x Screws for M.2 Module
- 1 x Phoenix plug connector
- 1 x System QIG

iEP-7041E-020 Series

- 1 x iEP-7041E-020
- 3 x Screws for M.2 Module
- 1 x Phoenix plug connector
- 1 x System QIG

iEP-7041E-021 Series

- 1 x iEP-7041E-021
- 2 x Screws for M.2 Module
- 1 x Phoenix plug connector
- · 1 x System QIG

iEP-7041E-022 Series

- 1 x iEP-7041E-022
- 2 x Screws for M.2 Module
- 1 x Phoenix plug connector
- · 1 x System QIG

iEP-7041E-023 Series

- 1 x iEP-7041E-023
- 2 x Screws for M.2 Module
- 1 x Phoenix plug connector
- 1 x System QIG

iEP-7041E-024 Series

- 1 x iEP-7041E-024
- 3 x Screws for M.2 Module
- 1 x Phoenix plug connector
- 1 x System QIG

iEP-7041E-025 Series

- 1 x iEP-7041E-025
- 3 x Screws for M.2 Module
- 1 x Phoenix plug connector
- 1 x System QIG



If any items are missing or appear damaged, contact your authorized dealer.

1.2 Order Information

Model Name	PN	SKU	CPU	Description
iEP-7040E-020	TBD	Basic SKU	255H	W/O RAM, SSD,
				Adapter
iEP-7040E-021	TBD	PoE SKU	255H	W/O RAM, SSD,
				Adapter
iEP-7040E-022	TBD	5LAN-WIFI	255H	W/O RAM, SSD,
		SKU		Adapter
iEP-7040E-023	TBD	5LAN-5G	255H	W/O RAM, SSD,
		SKU		Adapter
iEP-7040E-024	TBD	5G-WIFI	255H	W/O RAM, SSD,
		SKU		Adapter
iEP-7040E-025	TBD	8DIO SKU	255H	W/O RAM, SSD,
				Adapter
iEP-7041E-020	TBD	Basic SKU	255H	W/O RAM, SSD,
				Adapter
iEP-7041E-021	TBD	PoE SKU	255H	W/O RAM, SSD,
				Adapter
iEP-7041E-022	TBD	5LAN-WIFI	255H	W/O RAM, SSD,
		SKU		Adapter
iEP-7041E-023	TBD	5LAN-5G	255H	W/O RAM, SSD,
		SKU		Adapter
iEP-7041E-024	TBD	5G-WIFI	255H	W/O RAM, SSD,
		SKU		Adapter
iEP-7041E-025	TBD	8DIO SKU	255H	W/O RAM, SSD,
				Adapter

1.3 Optional Items

Model Name	PN	Description
Wall Mount	13G020760000AI	Attach the wall mounting brackets to the iEP-
Kits		7040E Series.
Din Rail Kits	13G020761000AI	Attach the Din Rail brackets to the iEP-7040E
		Series to place the system onto the Din Rail.
Wall Mount Kit	13G0207860A0AI	Attach the wall mounting brackets to the
		Basic SKU and 8DIO SKU.
VESA Mount	13G020554010AI	Attach the VESA mount brackets to the Basic
Kit		SKU and 8DIO SKU.
4G LTE KITS	90PCA2P0-00000004	4G Module x1, Antena x2, SMA Cable x2
5G KITS	90PCA2P0-00000003	5G Module x1, Antena x4, SMA Cable x4
WIFI KITS	90PCA2P0-00000000	WIFI Module x1, Antena x2, SMA Cable x2
Adapter	04G266001001AI	Adapter 120W 19V W/O CONN
		(For Basic/5LAN/5G/8DIO SKU)
	04G266001200AI	Adapter 330W 19V W/O CONN
		(For PoE SKU)

1.4 Product Specifications

1.4.1 System: iEP-7040E-020

	CPU	Intel® Core™ Ultra Processor 255H
	Frequency	2.0 GHz
Processor	TDP	28W
	BIOS	AMI EFI 256 Mbit
	Technology	DDR5 5600 MHz
Memory	Max Capacity	64GB
,	Socket	Dual 262-pin SO-DIMM
	Chipset	Intel® Arc™ graphics
Graphics	T	1 x HDMI 2.0b
	Interface	1 x VGA"
	RF&Antenna	7 x Antenna Hole
Expansion Slots	M.2	1 x M.2 3042/3052 Key B (PCIe Gen3x1/USB3.2 mode) 1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0 mode) - Support Wifi/BT Module
	SIM Slot	1 x Nano SIM Card
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out
	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)
	USB	3 x USB3.2 Gen2x1, 1 x USB2
I/O Interface	GPIO	8-bit Programmable DIO
	Function	1 x Power on button with LED 2 x Diagnostic LED 2 x DC-IN LED
Committee	Watch Dog	255-level timer interval, set up through software
Security	TPM	TPM 2.0
	Input 1	DC 9V to 36V, Redundant Power Input
Power Requirement	Input 2	DC 9V to 36V, Redundant Power Input
Requirement	Interface	3-pin Terminal Block : V+, V-, Ground
	Operating Temp.	-25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s
	Storage Temp.	-40°C ~ 85°C (-40°F~185°F)
	Humidity	~95% @ 40°C (non-condensing)
T	Shock	Operating with SSD: 100 G, half sine 11 ms duration
Environment	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes
	ESD	Contact +/-8 KV, Air +/-15 KV
	EMC	CE and FCC Class A (EN61000-6-4/-2)
	Safety	LVD
	Mounting	Din-Rail, Wall Mount, VESA Mount (Optional)
Mechanical	Dimensions	58mm (W) x 134mm (D) x 170mm (H)
	Net Weight	TBD
Add-on Support	OS	Windows 11, Linux

1.4.2 System: iEP-7041E-020

	CPU	Intel® Core™ Ultra Processor 255H
D	Frequency	1.7 GHz
Processor	TDP	28W
	BIOS	AMI EFI 256 Mbit
	Technology	DDR5 5600 MHz
Memory	Max Capacity	64GB
	Socket	Dual 262-pin SO-DIMM
	Chipset	Intel® Arc™ graphics
Graphics	Interface	1 x HDMI 2.0b 1 x VGA
	RF&Antenna	7 x Antenna Hole
Expansion Slots	M.2	1 x M.2 3042/3052 Key B (PCIe Gen3x1/USB3.2 mode) 1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0 mode) - Support Wifi/BT Module
	SIM Slot	1 x Nano SIM Card
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out
	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)
	USB	3 x USB3.2 Gen2x1, 1 x USB2
I/O Interface	GPIO	8-bit Programmable DIO
	Function	1 x Power on button with LED 2 x Diagnostic LED 2 x DC-IN LED
0 '	Watch Dog	255-level timer interval, set up through software
Security	TPM	TPM 2.0
_	Input 1	DC 9V to 36V, Redundant Power Input
Power Requirement	Input 2	DC 9V to 36V, Redundant Power Input
Requirement	Interface	3-pin Terminal Block : V+, V-, Ground
	Operating Temp.	-25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s
	Storage Temp.	-40°C ~ 85°C (-40°F~185°F)
	Humidity	~95% @ 40°C (non-condensing)
	Shock	Operating with SSD: 100 G, half sine 11 ms duration
Environment	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes
	ESD	Contact +/-8 KV, Air +/-15 KV
	EMC	CE and FCC Class A (EN61000-6-4/-2)
	Safety	LVD
	Mounting	Din-Rail, Wall Mount, VESA Mount (Optional)
Mechanical	Dimensions	58mm (W) x 134mm (D) x 170mm (H)
	Net Weight	TBD
Add-on Support	OS	Windows 11, Linux

1.4.3 System: iEP-7040E-021

	CPU	Intel® Core™ Ultra Processor 255H
	Frequency	2.0 GHz
Processor	TDP	28W
	BIOS	AMI EFI 256 Mbit
	Technology	DDR5 5600 MHz
Memory	Max Capacity	64GB
	Socket	Dual 262-pin SO-DIMM
	Chipset	Intel® Arc™ graphics
Graphics	Intended	1 x HDMI 2.0b
	Interface	1 x VGA
	RF&Antenna	5 x Antenna Hole
		1 x M.2 3042/3052 Key B (PCIe Gen3.1/USB3.2 mode) - Support PoE Module
Expansion Slots	M.2	1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0
	22.2.2	mode) - Support Wifi/BT Module
	SIM Slot	1 x Nano SIM Card
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out
	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN4/PoE1	Intel I210-AT, supports IEEE 802.3AF PoE, RJ45, 8P8C
	LAN5/PoE2	Intel I210-AT, supports IEEE 802.3AF PoE, RJ45, 8P8C
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)
	USB	3 x USB3.2 Gen2x1, 1 x USB2
I/O Interface	GPIO	8-bit Programmable DIO
	Function	1 x Power on button with LED
	runction	2 x Diagnostic LED 2 x DC-IN LED
	Watch Dog	255-level timer interval, set up through software
Security	TPM	TPM 2.0
	Input 1	DC 19V to 36V, Redundant Power Input
Power	Input 2	DC 19V to 36V, Redundant Power Input
Requirement	Interface	3-pin Terminal Block: V+, V-, Ground
	Operating Temp.	-25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s
	Storage Temp.	-40°C ~ 85°C (-40°F~185°F)
	Humidity	~95% @ 40°C (non-condensing)
	Shock	Operating with SSD: 100 G, half sine 11 ms duration
Environment	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes
	ESD	Contact +/-8 KV, Air +/-15 KV
	EMC	CE and FCC Class A (EN61000-6-4/-2)
	Safety	LVD
	Mounting	Din-Rail, Wall Mount (Optional)
Mechanical	Dimensions	68mm (W) x 134mm (D) x 170mm (H)
	Net Weight	TBD
Add-on Support	OS	Windows 11, Linux

1.4.4 System: iEP-7041E-021

	CPU	Intel® Core™ Ultra Processor 255H
	Frequency	1.7 GHz
Processor	TDP	28W
	BIOS	AMI EFI 256 Mbit
	Technology	DDR5 5600 MHz
Memory	Max Capacity	64GB
	Socket	Dual 262-pin SO-DIMM
	Chipset	Intel® Arc™ graphics
Graphics	1	1 x HDMI 2.0b
	Interface	1 x VGA
	RF&Antenna	5 x Antenna Hole
		1 x M.2 3042/3052 Key B (PCIe Gen3.1/USB3.2 mode) - Support
	M.2	PoE Module
Expansion Slots		1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0
	SIM Slot	mode) - Support Wifi/BT Module 1 x Nano SIM Card
	SD Slot	
A 11 .		1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out
	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN4/PoE1	Intel I210-AT, supports IEEE 802.3AF PoE, RJ45, 8P8C
	LAN5/PoE2	Intel I210-AT, supports IEEE 802.3AF PoE, RJ45, 8P8C
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)
	USB	3 x USB3.2 Gen2x1, 1 x USB2
I/O Interface	GPIO	8-bit Programmable DIO
	P	1 x Power on button with LED
	Function	2 x Diagnostic LED 2 x DC-IN LED
	Watch Dog	255-level timer interval, set up through software
Security	TPM	TPM 2.0
	Input 1	DC 19V to 36V, Redundant Power Input
Power	Input 2	DC 19V to 36V, Redundant Power Input
Requirement	Input 2 Interface	1
		3-pin Terminal Block : V+, V-, Ground -25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s
	Operating Temp.	-40°C ~ 85°C (-40°F~185°F)
	Storage Temp.	
	Humidity	~95% @ 40°C (non-condensing)
Environment	Shock	Operating with SSD: 100 G, half sine 11 ms duration
	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes
	ESD	Contact +/-8 KV, Air +/-15 KV
	EMC	CE and FCC Class A (EN61000-6-4/-2)
	Safety	LVD
36 1 1 1	Mounting	Din-Rail, Wall Mount (Optional)
Mechanical	Dimensions	68mm (W) x 134mm (D) x 170mm (H)
4.11	Net Weight	TBD
Add-on Support	OS	Windows 11, Linux

1.4.5 System: iEP-7040E-022

	CPU	Intel® Core™ Ultra Processor 255H
	Frequency	2.0 GHz
Processor	TDP	28W
	BIOS	AMI EFI 256 Mbit
	Technology	DDR5 5600 MHz
Memory	Max Capacity	64GB
	Socket	Dual 262-pin SO-DIMM
	Chipset	Intel® Arc™ graphics
Graphics	Interface	1 x HDMI 2.0b
	Interface	1 x VGA
	RF&Antenna	5 x Antenna Hole
		1 x M.2 3042/3052 Key B (PCIe Gen3.1/USB3.2 mode) - Support
	M.2	2-LAN Port Module 1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0
Expansion Slots		mode) - Support Wifi/BT Module
	SIM Slot	1 x Nano SIM Card
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out
	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN4	Intel I210-AT, 10/100/1000Mbps, RJ45, 8P8C
	LAN5	Intel I210-AT, 10/100/1000Mbps, RJ45, 8P8C
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)
	USB	3 x USB3.2 Gen2x1, 1 x USB2
I/O Interface	GPIO	8-bit Programmable DIO
		1 x Power on button with LED
	Function	2 x Diagnostic LED
	Matala Dan	2 x DC-IN LED
Security	Watch Dog	255-level timer interval, set up through software
	TPM	TPM 2.0
Power	Input 1	DC 9V to 36V, Redundant Power Input
Requirement	Input 2 Interface	DC 9V to 36V, Redundant Power Input
		3-pin Terminal Block: V+, V-, Ground
	Operating Temp.	-25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s
	Storage Temp. Humidity	-40°C ~ 85°C (-40°F~185°F)
	Shock	~95% @ 40°C (non-condensing) Operating with SSD: 100 G, half sine 11 ms duration
Environment	Vibration	Operating with SSD: 100 G, half sine 11 his duration Operating with SSD: 5 Grms, 5-500 Hz, 3 axes
	ESD	Contact +/-8 KV, Air +/-15 KV
	EMC	CE and FCC Class A (EN61000-6-4/-2)
	Safety	LVD
	Mounting	Din-Rail, Wall Mount (Optional)
Mechanical	Dimensions	68mm (W) x 134mm (D) x 170mm (H)
Wicchaincai	Net Weight	TBD
Add-on Support	OS OS	Windows 11, Linux
rida on support	100	11 IIIuo 11 I, LiiiuA

1.4.6 System: iEP-7041E-022

	CPU	Intel® Core™ Ultra Processor 255H
	Frequency	1.7 GHz
Processor	TDP	28W
	BIOS	AMI EFI 256 Mbit
	Technology	DDR5 5600 MHz
Memory	Max Capacity	64GB
	Socket	Dual 262-pin SO-DIMM
	Chipset	Intel® Arc™ graphics
Graphics	T	1 x HDMI 2.0b
	Interface	1 x VGA
	RF&Antenna	5 x Antenna Hole
		1 x M.2 3042/3052 Key B (PCIe Gen3.1/USB3.2 mode) - Support
	M.2	2-LAN Port Module
Expansion Slots		1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0 mode) - Support Wifi/BT Module
	SIM Slot	1 x Nano SIM Card
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out
rudio	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Building	LAN4	Intel I210-AT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN5	Intel I210-AT, 10/100/1000Mbps, RJ45, 8P8C
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)
	USB	3 x USB3.2 Gen2x1, 1 x USB2
I/O Interface	GPIO	8-bit Programmable DIO
1/O Interface		1 x Power on button with LED
	Function	2 x Diagnostic LED
		2 x DC-IN LED
Security	Watch Dog	255-level timer interval, set up through software
	TPM	TPM 2.0
Power	Input 1	DC 9V to 36V, Redundant Power Input
Requirement	Input 2	DC 9V to 36V, Redundant Power Input
1	Interface	3-pin Terminal Block : V+, V-, Ground
	Operating Temp.	-25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s
	Storage Temp.	-40°C ~ 85°C (-40°F~185°F)
	Humidity	~95% @ 40°C (non-condensing)
Environment	Shock	Operating with SSD: 100 G, half sine 11 ms duration
	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes
	ESD	Contact +/-8 KV, Air +/-15 KV
	EMC	CE and FCC Class A (EN61000-6-4/-2)
	Safety	LVD
	Mounting	Din-Rail, Wall Mount (Optional)
Mechanical	Dimensions	68mm (W) x 134mm (D) x 170mm (H)
	Net Weight	TBD
Add-on Support	OS	Windows 11, Linux

1.4.7 System: iEP-7040E-023

	CPU	Intel® Core™ Ultra Processor 255H
Dunganan	Frequency	2.0 GHz
Processor	TDP	28W
	BIOS	AMI EFI 256 Mbit
	Technology	DDR5 5600 MHz
Memory	Max Capacity	64GB
	Socket	Dual 262-pin SO-DIMM
	Chipset	Intel® Arc™ graphics
Graphics	Interface	1 x HDMI 2.0b
	interrace	1 x VGA
	RF&Antenna	5 x Antenna Hole
		1 x M.2 3042/3052 Key B (PCIe Gen3.1/USB3.2 mode) - Support
F	M.2	4G LTE/5G Module 1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0
Expansion Slots		mode) - Support 2-LAN Port Module
	SIM Slot	1 x Nano SIM Card
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out
	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN4	Intel I210-AT, 10/100/1000Mbps, RJ45, 8P8C
	LAN5	Intel I210-AT, 10/100/1000Mbps, RJ45, 8P8C
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)
	USB	3 x USB3.2 Gen2x1, 1 x USB2
I/O Interface	GPIO	8-bit Programmable DIO
1/O Interface		1 x Power on button with LED
	Function	2 x Diagnostic LED
		2 x DC-IN LED
Security	Watch Dog	255-level timer interval, set up through software
· ·	TPM	TPM 2.0
Power	Input 1	DC 9V to 36V, Redundant Power Input
Requirement	Input 2	DC 9V to 36V, Redundant Power Input
	Interface	3-pin Terminal Block : V+, V-, Ground
	Operating Temp.	
	Storage Temp.	-40°C ~ 85°C (-40°F~185°F)
	Humidity	~95% @ 40°C (non-condensing)
Environment	Shock	Operating with SSD: 100 G, half sine 11 ms duration
	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes
	ESD	Contact +/-8 KV, Air +/-15 KV
	EMC	CE and FCC Class A (EN61000-6-4/-2)
	Safety	LVD
Madantal	Mounting	Din-Rail, Wall Mount (Optional)
Mechanical	Dimensions	68mm (W) x 134mm (D) x 170mm (H)
A 11 C	Net Weight	TBD
Add-on Support	OS	Windows 11, Linux

1.4.8 System: iEP-7041E-023

	CPU	Intel® Core™ Ultra Processor 255H
	Frequency	1.7 GHz
Processor	TDP	28W
	BIOS	AMI EFI 256 Mbit
	Technology	DDR5 5600 MHz
Memory	Max Capacity	64GB
	Socket	Dual 262-pin SO-DIMM
	Chipset	Intel® Arc™ graphics
Graphics	1	1 x HDMI 2.0b
	Interface	1 x VGA
	RF&Antenna	5 x Antenna Hole
		1 x M.2 3042/3052 Key B (PCIe Gen3.1/USB3.2 mode) - Support
	M.2	4G LTE/5G Module
Expansion Slots		1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0 mode) - Support 2-LAN Port Module
	SIM Slot	1 x Nano SIM Card
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out
Audio	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN4	
	LAN4 LAN5	Intel I210-AT, 10/100/1000Mbps, RJ45, 8P8C
Chamana	M.2	Intel I210-AT, 10/100/1000Mbps, RJ45, 8P8C
Storage	M.2 Serial Port	1 x M.2 2280 Key M (PCIe Gen4x4)
		3 x RS-232/422/485 (9-pin D-sub connector)
	USB GPIO	3 x USB3.2 Gen2x1, 1 x USB2
I/O Interface	GPIO	8-bit Programmable DIO
	Function	1 x Power on button with LED 2 x Diagnostic LED
	1 unction	2 x DC-IN LED
	Watch Dog	255-level timer interval, set up through software
Security	TPM	TPM 2.0
	Input 1	DC 9V to 36V, Redundant Power Input
Power	Input 2	DC 9V to 36V, Redundant Power Input
Requirement	Interface	3-pin Terminal Block : V+, V-, Ground
	Operating Temp.	-25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s
	Storage Temp.	-40°C ~ 85°C (-40°F~185°F)
	Humidity	~95% @ 40°C (non-condensing)
	Shock	Operating with SSD: 100 G, half sine 11 ms duration
Environment	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes
	ESD	Contact +/-8 KV, Air +/-15 KV
	EMC	CE and FCC Class A (EN61000-6-4/-2)
	Safety	LVD
	Mounting	Din-Rail, Wall Mount (Optional)
Mechanical	Dimensions	68mm (W) x 134mm (D) x 170mm (H)
	Net Weight	TBD
Add-on Support	os	Windows 11, Linux

1.4.9 System: iEP-7040E-024

	CPU	Intel® Core™ Ultra Processor 255H	
Processor	Frequency	2.0 GHz	
	TDP	28W	
	BIOS	AMI EFI 256 Mbit	
	Technology	DDR5 5600 MHz	
Memory	Max Capacity	64GB	
	Socket	Dual 262-pin SO-DIMM	
	Chipset	Intel® Arc™ graphics	
Graphics	Intended	1 x HDMI 2.0b	
	Interface	1 x VGA	
	RF&Antenna	7 x Antenna Hole	
Expansion Slots	M.2	1 x M.2 3042/3052 Key B (PCIe Gen3.1/USB3.2 mode) - Support 4G LTE/5G Module 1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0 mode) - Support Wifi/BT Module	
	SIM Slot	1 x Nano SIM Card	
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)	
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out	
	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C	
Ethernet	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C	
	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C	
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)	
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)	
	USB	3 x USB3.2 Gen2x1, 1 x USB2	
I/O Interface	GPIO	8-bit Programmable DIO	
	Function	1 x Power on button with LED 2 x Diagnostic LED 2 x DC-IN LED	
0	Watch Dog	255-level timer interval, set up through software	
Security	TPM	TPM 2.0	
	Input 1	DC 9V to 36V, Redundant Power Input	
Power Requirement	Input 2	DC 9V to 36V, Redundant Power Input	
Requirement	Interface	3-pin Terminal Block: V+, V-, Ground	
	Operating Temp.	-25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s	
	Storage Temp.	-40°C ~ 85°C (-40°F~185°F)	
	Humidity	~95% @ 40°C (non-condensing)	
Environment	Shock	Operating with SSD: 100 G, half sine 11 ms duration	
Environment	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes	
	ESD	Contact +/-8 KV, Air +/-15 KV	
	EMC	CE and FCC Class A (EN61000-6-4/-2)	
	Safety	LVD	
	Mounting	Din-Rail, Wall Mount (Optional)	
Mechanical	Dimensions	68mm (W) x 134mm (D) x 170mm (H)	
	Net Weight	TBD	
Add-on Support	OS	Windows 11, Linux	

1.4.10 System: iEP-7041E-024

	CPU	Intel® Core™ Ultra Processor 255H
	Frequency	1.7 GHz
Processor	TDP	28W
	BIOS	AMI EFI 256 Mbit
	Technology	DDR5 5600 MHz
Memory	Max Capacity	64GB
	Socket	Dual 262-pin SO-DIMM
	Chipset	Intel® Arc™ graphics
Graphics	T	1 x HDMI 2.0b
, î	Interface	1 x VGA
	RF&Antenna	7 x Antenna Hole
Expansion Slots	M.2	1 x M.2 3042/3052 Key B (PCIe Gen3.1/USB3.2 mode) - Support 4G LTE/5G Module 1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0 mode) - Support Wifi/BT Module
	SIM Slot	1 x Nano SIM Card
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out
	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)
	USB	3 x USB3.2 Gen2x1, 1 x USB2
I/O Interface	GPIO	8-bit Programmable DIO
2,0 2.1100.1100	Function	1 x Power on button with LED 2 x Diagnostic LED 2 x DC-IN LED
C't	Watch Dog	255-level timer interval, set up through software
Security	TPM	TPM 2.0
	Input 1	DC 9V to 36V, Redundant Power Input
Power Requirement	Input 2	DC 9V to 36V, Redundant Power Input
requirement	Interface	3-pin Terminal Block : V+, V-, Ground
	Operating Temp.	-25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s
	Storage Temp.	-40°C ~ 85°C (-40°F~185°F)
	Humidity	~95% @ 40°C (non-condensing)
Paratas a marca 4	Shock	Operating with SSD: 100 G, half sine 11 ms duration
Environment	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes
	ESD	Contact +/-8 KV, Air +/-15 KV
	EMC	CE and FCC Class A (EN61000-6-4/-2)
	Safety	LVD
	Mounting	Din-Rail, Wall Mount (Optional)
Mechanical	Dimensions	68mm (W) x 134mm (D) x 170mm (H)
	Net Weight	TBD
Add-on Support	OS	Windows 11, Linux

1.4.11 System: iEP-7040E-025

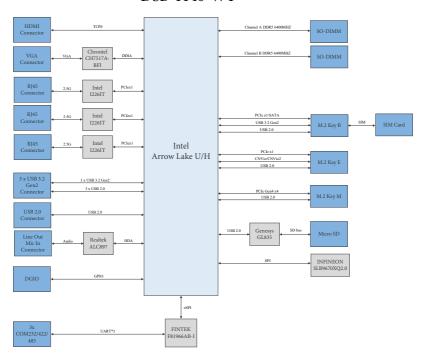
	CPU	Intel® Core™ Ultra Processor 255H	
	Frequency	2.0 GHz	
Processor	TDP	28W	
	BIOS	AMI EFI 256 Mbit	
	Technology	DDR5 5600 MHz	
Memory	Max Capacity	64GB	
,	Socket	Dual 262-pin SO-DIMM	
	Chipset	Intel® Arc™ graphics	
Graphics	*	1 x HDMI 2.0b	
*	Interface	1 x VGA	
	RF&Antenna	5 x Antenna Hole	
Expansion Slots	M.2	1 x M.2 3042/3052 Key B (PCIe Gen3.1/USB3.2 mode) 1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0 mode) - Support Wifi/BT Module	
	SIM Slot	1 x Nano SIM Card	
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)	
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out	
	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C	
Ethernet	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C	
	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C	
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)	
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)	
	USB	3 x USB3.2 Gen2x1, 1 x USB2	
	GPIO	8-bit Programmable DIO	
I/O Interface	Digital I/O	8DIs/8DOs with sink/source isolation 36V (2x10-pin connector)	
	Function	1 x Power on button with LED 2 x Diagnostic LED 2 x DC-IN LED	
o :	Watch Dog	255-level timer interval, set up through software	
Security	TPM	TPM 2.0	
	Input 1	DC 9V to 36V, Redundant Power Input	
Power	Input 2	DC 9V to 36V, Redundant Power Input	
Requirement	Interface	3-pin Terminal Block : V+, V-, Ground	
	Operating Temp.	-25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s	
	Storage Temp.	-40°C ~ 85°C (-40°F~185°F)	
	Humidity	~95% @ 40°C (non-condensing)	
	Shock	Operating with SSD: 100 G, half sine 11 ms duration	
Environment	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes	
	ESD	Contact +/-8 KV, Air +/-15 KV	
	EMC	CE and FCC Class A (EN61000-6-4/-2)	
	Safety	LVD	
	Mounting	Din-Rail, Wall Mount, VESA Mount (Optional)	
Mechanical	Dimensions	58mm (W) x 134mm (D) x 170mm (H)	
	Net Weight	TBD	
Add-on Support	OS	Windows 11, Linux	

1.4.12 System: iEP-7041E-025

	CPU	Intel® Core™ Ultra Processor 255H
	Frequency	1.7 GHz
Processor	TDP	28W
	BIOS	AMI EFI 256 Mbit
	Technology	DDR5 5600 MHz
Memory	Max Capacity	64GB
·	Socket	Dual 262-pin SO-DIMM
	Chipset	Intel® Arc™ graphics
Graphics	_	1 x HDMI 2.0b
· •	Interface	1 x VGA
	RF&Antenna	5 x Antenna Hole
Expansion Slots	M.2	1 x M.2 3042/3052 Key B (PCIe Gen3.1/USB3.2 mode) 1 x M.2 2230/2260 Key E (CNVio/CNVio2/PCIe Gen3x1/USB2.0 mode) - Support Wifi/BT Module
	SIM Slot	1 x Nano SIM Card
	SD Slot	1 x Micro SD Card (SD specification v3.0 UHS-I: SDR25/SDR50)
Audio	Interface	Realtek ALC897, High Definition Audio, Mic-In, Line-Out
	LAN1	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Ethernet	LAN2	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
	LAN3	Intel I226-IT, 10/100/1000/2500Mbps, RJ45, 8P8C
Storage	M.2	1 x M.2 2280 Key M (PCIe Gen4x4)
	Serial Port	3 x RS-232/422/485 (9-pin D-sub connector)
	USB	3 x USB3.2 Gen2x1, 1 x USB2
	GPIO	8-bit Programmable DIO
I/O Interface	Digital I/O	8DIs/8DOs with sink/source isolation 36V (2x10-pin connector)
	Function	1 x Power on button with LED 2 x Diagnostic LED 2 x DC-IN LED
0 '	Watch Dog	255-level timer interval, set up through software
Security	TPM	TPM 2.0
	Input 1	DC 9V to 36V, Redundant Power Input
Power	Input 2	DC 9V to 36V, Redundant Power Input
Requirement	Interface	3-pin Terminal Block : V+, V-, Ground
	Operating Temp.	-25°C ~ 50°C (-13°F~122°F), w/airflow 0.5~0.8m/s
	Storage Temp.	-40°C ~ 85°C (-40°F~185°F)
	Humidity	~95% @ 40°C (non-condensing)
Environment	Shock	Operating with SSD: 100 G, half sine 11 ms duration
Environment	Vibration	Operating with SSD: 5 Grms, 5-500 Hz, 3 axes
	ESD	Contact +/-8 KV, Air +/-15 KV
	EMC	CE and FCC Class A (EN61000-6-4/-2)
	Safety	LVD
	Mounting	Din-Rail, Wall Mount, VESA Mount (Optional)
Mechanical	Dimensions	58mm (W) x 134mm (D) x 170mm (H)
	Net Weight	TBD
Add-on Support	OS	Windows 11, Linux

1.5 Block Diagram

DSB-1140-WT

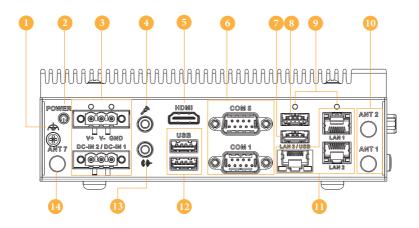


Chapter 2 Product Overview

This chapter provides diagrams showing the location of important components of the iEP- 7040E Series.

2.1 System Front Panel

2.1.1 System: iEP-7040E-020, iEP-7041E-020, iEP-7040E-025, iEP-7041E-025



No.	Description						
1	Ground : The functional earth ground provides you with a grounding point.						
2	Power Button :	The power button allo	ows you to turn the iEP-7040E Series on or				
	off. You can use	the power button to p	out your iEP-7040E Series into sleep mode or				
	press it for four s	seconds to shut down	you system.				
3	DC-IN Connect	tors: The V+ and V-1	oins provide DC power input and the				
	chassis ground p	oin allows connection	of the chassis to ground for better EMC				
	compatibility. Tl	compatibility. The DC power input for the iEP-703XE series supports a voltage					
	input range fron	-	0				
			1 1 3				
	Pin	Signal name					
	1	V+					
	2	V-					
	3	GND					

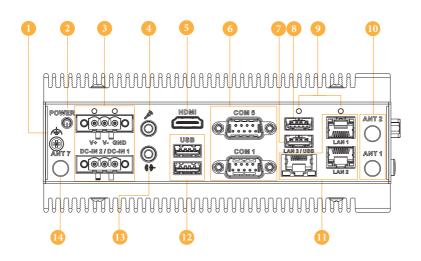
Audio (Mic-In): The Mic-in audio connector on the I/O panel supports 5.1 channel HD audio and fully complies with Intel® High Definition Audio specifications. 5 **HDMI**: The HDMI port supports a Full-HD device to allow viewing on a larger external display. Serial (COM) Ports*: The 9-pin RS232/422/485 serial connector allows you to 6 connect devices that have serial ports. * This motherboard supports RS232/422/485 on COM1, 5 ports. Please refer to table below for the pin definition. In addition, COM1, 5 ports (RS232/422/485) can be adjusted in BIOS setup utility > Advanced Screen > Super IO Configuration. You may refer to our user manual for details. COM1, 5 Ports Pin Definition RS232 RS422 RS485 Pin RTX-TX-1 DCD, Data Carrier Detect 2 RXD, Receive Data TX+ RTX+ TXD, Transmit Data RX+ NA DTR, Data Terminal Ready RX-NA GND GND GND DSR, Data Set Ready NA NA 6 RTS, Request To Send NA NA CTS, Clear To Send NA NA NA 9 NA NA **USB 2.0 port**: The USB port is compatible with USB 2.0 or USB 1.1 devices. 8, 12 USB 3.2 Gen2x1 port: The USB 3.2 Gen2x1 port provides a transfer rate up to 10 Gbit/s. **Diagnostic LEDs****: These LEDs indicate the debug status of the motherboard. Please refer to the table below to get more information about the Diagnostic LED. Antenna Holes: The antenna holes allow you to connect a wireless antenna to 10, 14 enhance wireless signal reception. LAN ports***: The RJ45 8P8C LAN port supports a standard Ethernet cable for 11 10/100/1000/2500 Mbps connection to the local network, is capable of bridging, and can perform auto-negotiation.

Audio (Line-Out): The port connects speakers to the Line-out connector for

13

better sound quality.

2.1.2 System: iEP-7040E-021, iEP-7041E-021, iEP-7040E-022, iEP-7041E-022, iEP-7040E-023, iEP-7041E-023, iEP-7040E-024, iEP-7041E-024



	Description						
1	Ground: The fu	ınctional earth groun	d provides you with a grounding point.				
2	Power Button :	The power button allo	ws you to turn the iEP-7040E Series on or				
	off. You can use	the power button to p	out your iEP-7040E Series into sleep mode or				
	press it for four	seconds to shut down	you system.				
3	DC-IN Connec	tors: The V+ and V- p	oins provide DC power input and the				
	chassis ground	pin allows connection	of the chassis to ground for better EMC				
	compatibility. The DC power input for the iEP-703XE series supports a voltage						
	input range from 9V or 19V to 36V DC.						
	Pin	Signal name	1 3				
	1	V+					
	2	V-					
	3	GND					

4	Audio (M	(ic-In) : The Mic-in au	dio connector on the	I/O panel supports 5.1			
	channel F	channel HD audio and fully complies with Intel® High Definition Audio					
	specifications.						
5	-		rts a Full-HD device	to allow viewing on a la	rger		
	external		110 41 411 112 40 1100	to uno w viewing on une	.1801		
6		1 /	n D\$222/422/485 cori	al connector allows you	1 to		
0		•		ai connector anows you	110		
	connect d	evices that have serial	ports.				
	* This mo	therboard supports RS232/42	2/485 on COM1, 5 ports. Pl	ease refer to table below for the	2		
	pin definit	tion. In addition, COM1, 5 po	orts (RS232/422/485) can be	adjusted in BIOS setup utility >	>		
	Advanced	Screen > Super IO Configurat	tion. You may refer to our us	er manual for details.			
		COM1	, 5 Ports Pin Definiti	on			
	Pin	RS232	RS422	RS485			
	1	DCD, Data Carrier Detect	TX-	RTX-			
	2	RXD, Receive Data	TX+	RTX+			
	3	TXD, Transmit Data	RX+	NA			
	4	DTR, Data Terminal Ready	RX-	NA			
	5	GND	GND	GND			
	6	DSR, Data Set Ready	NA	NA			
	7	RTS, Request To Send	NA	NA			
	8	CTS, Clear To Send	NA	NA			
	9 NA NA NA						
7	USB 2.0 p	ort: The USB port is	compatible with USE	3 2.0 or USB 1.1 devices.			
8, 12	USB 3.2 (Gen2x1 port : The USI	B 3.2 Gen2x1 port pr	ovides a transfer rate up	to 10		
	Gbit/s.						
9	Diagnostic LEDs** : These LEDs indicate the debug status of the motherboard.						
	Please refer to the table below to get more information about the Diagnostic LED.						
10,	Antenna Holes: The antenna holes allow you to connect a wireless antenna to						
14	enhance wireless signal reception.						
11		LAN ports***: The RJ45 8P8C LAN port supports a standard Ethernet cable for					
	10/100/10	00/2500 Mbps connec	ction to the local nety	work, is capable of bridg	ging,		
		erform auto-negotiati		,	,,		
13	-			a Lina out connector f	0.5		
13	Audio (L)	Audio (Line-Out): The port connects speakers to the Line-out connector for					

Antenna Hole: The antenna hole allows you to connect a wireless antenna to

better sound quality.

enhance wireless signal reception.

15

** Please refer to	the table below	for the Diagnostic	LED indications

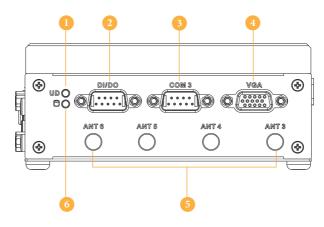
Item	LED1	LED2	BIOS Status Code	Description
	White	White	0x15	PEI_CAR_NB_INIT
CPU	White	Blue	0x32	PEI_CPU_INIT
	White	Yellow	0x68	DXE_NB_HB_INIT
	White	Red	0x19	PEI_CAR_SB_INIT
	Blue	White	0x4F	PEI_DXE_IPL_STARTED
DDAM	Blue	Blue	0x51	PEI_MEMORY_SPD_FAIL
DRAM	Blue	Yellow	0x53	PEI_MEMORY_NOT_DETECT
	Blue	Red	0x54	PEI_MEMORY_ERROR
	Blue	Green	0x55	PEI_MEMORY_NOT_
				INSTALLED
	Yellow	White	0x70	DXE_SB_INIT
I/O PORT	Yellow	Blue	0x97	DXE_CON_OUT_CONNECT
	Yellow	Yellow	0x99	DXE_SIO_INIT
	Yellow	Red	0xD6	DXE_NO_CON_OUT
	Green	White	0x91	DXE_BDS_CONNECT_
				DRIVERS
BOOT	Green	Blue	0x94	DXE_PCI_BUS_ENUM
	Green	Yellow	0x9A	DXE_USB_BEGIN
	Green	Red	0xDA	DXE_BOOT_OPTION_FAILED
	Green	Green	0xA2	DXE_IDE_DETECT
	Red	Red	0xAB	ENTER BIOS SETUP
	None	None	0xAD	BOOT OS OR SHELL

^{***} There are two LEDs on the LAN port. Please refer to the table below for the LAN port LED indications.



2.2 System Top Panel

2.2.1 System: iEP-7040E-020, iEP-7041E-020



No.	Descr	iptio	n		
1				define LED ind	icator behaviors are based on the ASRI
	API li	brary	you use.		
2	GPIC	: Th	e 9-pin Digit	al Input / Outp	ut connector allows you to program it for
	input	or ou	tput use.		
		Pin	Definition	Mapping to PCH GPIO Function	1 2 3 4 5
		1	DIO0	GPP_B07	
		2	DIO2	GPP_B15	
		3	DIO4	GPP_D05	\ 0000 /
		4	DIO6	GPP_D08	2.7.0.0
		5	GND		6 7 8 9
		6	DIO1	GPP_B08	
		7	DIO3	GPP_B17	
		8	DIO5	GPP_D07	
		9	DIO7	GPP_D14	

3 **Serial (COM3) Port***: The 9-pin RS232/422/485 serial connector allows you to connect devices that have serial ports.

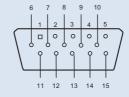
 * This motherboard supports RS232/422/485 on COM3 port. Please refer to table below for the pin definition. In addition, COM3 port (RS232/422/485) can be adjusted in BIOS setup utility > Advanced Screen > Super IO Configuration. You may refer to our user manual for details.

COM3 Port Pin Definition

Pin	RS232	RS422	RS485
1	DCD, Data Carrier Detect	TX-	RTX-
2	RXD, Receive Data	TX+	RTX+
3	TXD, Transmit Data	RX+	NA
4	DTR, Data Terminal Ready	RX-	NA
5	GND	GND	GND
6	DSR, Data Set Ready	NA	NA
7	RTS, Request To Send	NA	NA
8	CTS, Clear To Send	NA	NA
9	NA	NA	NA

4 **VGA:** Use a VGA cable to connect between the system and your monitor.

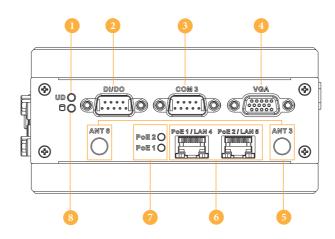
Pin	Signal	Signal	Pin
1	RED_VGA	NA	9
2	GRN_VGA	GND	10
3	BLU_VGA	NA	11
4	NA	VGA_SDA	12
5	GND	HS_5V	13
6	GND	VS_5V	14
7	GND	VGA_SCL	15
8	GND		



Antennas: The antenna hole allows you to connect a wireless antenna to enhance wireless signal reception.

6 **Storage LED**: Storage LED indicator behaviors vary depending on the storage module you use.

2.2.2 System: iEP-7040E-021, iEP-7041E-021, iEP-7040E-022, iEP-7041E-022, iEP-7040E-023, iEP-7041E-023



No.	Desc	riptic	n					
1		User Define LED : User define LED indicator behaviors are based on the ASRI						
2	API library you use. GPIO: The 9-pin Digital Input / Output connector allows you to program it for input or output use.							
		Pin	Definition	Mapping to PCH GPIO Function	1 2 3 4 5			
		1	DIO0	GPP_B07	\			
		2	DIO2	GPP_B15	\ 🛮 0 0 0 0 /			
		3	DIO4	GPP_D05	\			
		4	DIO6	GPP_D08	0.7.0.0			
		5	GND		6 7 8 9			
		6	DIO1	GPP_B08				
		7	DIO3	GPP_B17				
		8	DIO5	GPP_D07				
		9	DIO7	GPP D14				

3 Serial (COM3) Port*: The 9-pin RS232/422/485 serial connector allows you to connect devices that have serial ports.

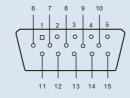
 * This motherboard supports RS232/422/485 on COM3 port. Please refer to table below for the pin definition. In addition, COM3 port (RS232/422/485) can be adjusted in BIOS setup utility > Advanced Screen > Super IO Configuration. You may refer to our user manual for details.

COM3 Port Pin Definition

Pin	RS232	RS422	RS485
1	DCD, Data Carrier Detect	TX-	RTX-
2	RXD, Receive Data	TX+	RTX+
3	TXD, Transmit Data	RX+	NA
4	DTR, Data Terminal Ready	RX-	NA
5	GND	GND	GND
6	DSR, Data Set Ready	NA	NA
7	RTS, Request To Send	NA	NA
8	CTS, Clear To Send	NA	NA
9	NA	NA	NA

4 **VGA:** Use a VGA cable to connect between the system and your monitor.

Pin	Signal	Signal	Pin
1	RED_VGA	NA	9
2	GRN_VGA	GND	10
3	BLU_VGA	NA	11
4	NA	VGA_SDA	12
5	GND	HS_5V	13
6	GND	VS_5V	14
7	GND	VGA_SCL	15
8	GND		



- 5 **Antennas :** The antenna hole allows you to connect a wireless antenna to enhance wireless signal reception.
- 6 LAN ports**: The RJ45 8P8C LAN ports support a standard Ethernet cable for connection to local network, and support PoE, is capable of bridging, and can perform auto-negotiation.

*However, these features require an operating system to be activated.

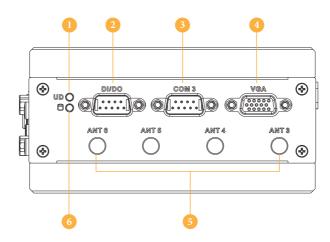
- PoE LEDs: This indicator lights up when your system is connected to PoE1/PoE2.
- 8 **Storage LED :** Storage LED indicator behaviors vary depending on the storage module you use.

 $^{^{**} \}textit{There are two LEDs on the LAN port. Please refer to the table below for the LAN port LED indications.}$



LAN Por

2.2.3 System: iEP-7040E-024, iEP-7041E-024



No.	Desci	riptio	n		
1	User	Defin	e LED : User	define LED ind	icator behaviors are based on the ASRI
	API l	ibrary	you use.		
2	GPIC) : Th	e 9-pin Digit	al Input / Outp	ut connector allows you to program it for
	input	or ou	tput use.		
		Pin	Definition	Mapping to PCH GPIO Function	1 2 3 4 5
		1	DIO0	GPP_B07	\
		2	DIO2	GPP_B15	
		3	DIO4	GPP_D05	\ 0000 /
		4	DIO6	GPP_D08	0.7.0.0
		5	GND		6 7 8 9
		6	DIO1	GPP_B08	
		7	DIO3	GPP_B17	
		8	DIO5	GPP_D07	
		9	DIO7	GPP_D14	

Serial (COM3) Port*: The 9-pin RS232/422/485 serial connector allows you to connect devices that have serial ports.

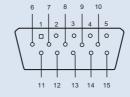
 * This motherboard supports RS232/422/485 on COM3 port. Please refer to table below for the pin definition. In addition, COM3 port (RS232/422/485) can be adjusted in BIOS setup utility > Advanced Screen > Super IO Configuration. You may refer to our user manual for details.

COM3 Port Pin Definition

Pin	RS232	RS422	RS485
1	DCD, Data Carrier Detect	TX-	RTX-
2	RXD, Receive Data	TX+	RTX+
3	TXD, Transmit Data	RX+	NA
4	DTR, Data Terminal Ready	RX-	NA
5	GND	GND	GND
6	DSR, Data Set Ready	NA	NA
7	RTS, Request To Send	NA	NA
8	CTS, Clear To Send	NA	NA
9	NA	NA	NA

VGA: Use a VGA cable to connect between the system and your monitor.

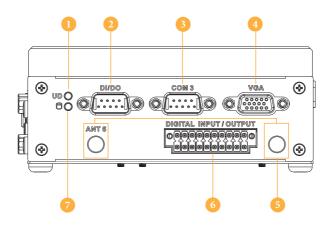
Pin	Signal	Signal	Pin
1	RED_VGA	NA	9
2	GRN_VGA	GND	10
3	BLU_VGA	NA	11
4	NA	VGA_SDA	12
5	GND	HS_5V	13
6	GND	VS_5V	14
7	GND	VGA_SCL	15
8	GND		



Antennas : The antenna hole allows you to connect a wireless antenna to enhance wireless signal reception.

Storage LED: Storage LED indicator behaviors vary depending on the storage module you use.

2.2.4 System: iEP-7040E-025, iEP-7041E-025



No.	Desci	riptio	n		
1	User	User Define LED: User define LED indicator behaviors are based on the ASRI			
	APIl	ibrary	you use.		
2	GPIC) : Th	e 9-pin Digit	al Input / Outp	ut connector allows you to program it for
	input	or ou	tput use.		
		Pin	Definition	Mapping to PCH GPIO Function	1 2 3 4 5
		1	DIO0	GPP_B07	\
		2	DIO2	GPP_B15	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
		3	DIO4	GPP_D05	\ 0000 /
		4	DIO6	GPP_D08	0.7.0.0
		5	GND		6 7 8 9
		6	DIO1	GPP_B08	
		7	DIO3	GPP_B17	
		8	DIO5	GPP_D07	
		9	DIO7	GPP_D14	

3 **Serial (COM3) Port***: The 9-pin RS232/422/485 serial connector allows you to connect devices that have serial ports.

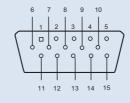
 * This motherboard supports RS232/422/485 on COM3 port. Please refer to table below for the pin definition. In addition, COM3 port (RS232/422/485) can be adjusted in BIOS setup utility > Advanced Screen > Super IO Configuration. You may refer to our user manual for details.

COM3 Port Pin Definition

Pin	RS232	RS422	RS485
1	DCD, Data Carrier Detect	TX-	RTX-
2	RXD, Receive Data	TX+	RTX+
3	TXD, Transmit Data	RX+	NA
4	DTR, Data Terminal Ready	RX-	NA
5	GND	GND	GND
6	DSR, Data Set Ready	NA	NA
7	RTS, Request To Send	NA	NA
8	CTS, Clear To Send	NA	NA
9	NA	NA	NA

VGA: Use a VGA cable to connect between the system and your monitor.

Pin	Signal	Signal	Pin
1	RED_VGA	NA	9
2	GRN_VGA	GND	10
3	BLU_VGA	NA	11
4	NA	VGA_SDA	12
5	GND	HS_5V	13
6	GND	VS_5V	14
7	GND	VGA_SCL	15
8	GND		



5 Antennas: The antenna hole allows you to connect a wireless antenna to enhance wireless signal reception.

6 **Digital I/O:** This system provides sink/source isolation 36V circuits for the customer's device.

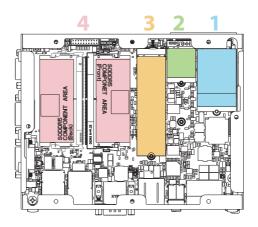
Pin	Signal	Signal	Pin
1	GND	GND	2
3	MCU_SPI0_ MOSI	GPP_E16	4
5	MCU_SPI0_ MISO	GPP_E7	6
7	MCU_SPI0_ CLK	GPP_E3	8
9	MCU_SPI0_SS	GPP_D3	10
11	GPP_A15	GPP_E13	12
13	GPP_A14	GPP_E2	14
15	ICE_CLK	GPP_E1	16
17	ICE_DAT	GPP_B15	18
19	+3V	+3V	20

7



Storage LED : Storage LED indicator behaviors vary depending on the storage module you use.

2.3 Inside View



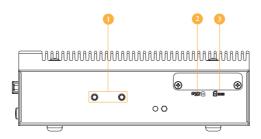
No.	Description
1	M.2 Slot (B Key): The M.2 slot allows you to install 3042/3052 4G LTE/5G
	module.
2	M.2 Slot (E Key): The M.2 slot allows you to install 2230 Wi-Fi/BT module and
	2230/2260 2-LAN Port module.
3	M.2 Slot (M Key): The M.2 slot allows you to install 2280 M.2 devices.
4	Memory: Dual Small Outline Dual Inline Memory module slots are designed for
	DDR5 memory modules



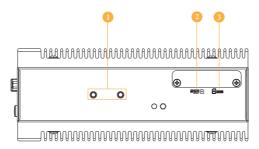
SO-DIMM memory, hard drive and M.2 SSD are not included with this system.

2.4 Rear View

• For Basic/8DIO SKU

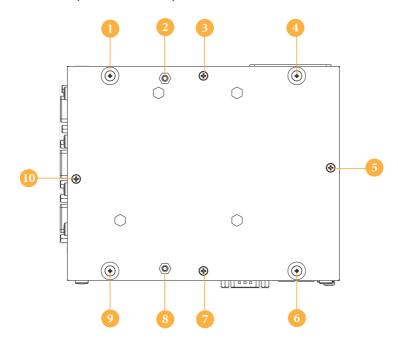


• For PoE/5LAN/5G SKU



No.	Description
1	Mounting Holes: The holes support Wall Mount and DIN Rail brackets for
	system in vertical position.
2	Micro SD Slot: The slot supports Micro SD card.
3	SIM Card Slot: The SIM Card slot allows you to install a Nano type SIM card.

2.5 Right View (System: iEP-7040E-020, iEP-7041E-020, iEP-7040E-025, iEP-7041E-025)

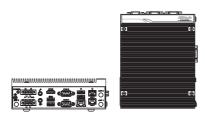


No.	Description
1, 4, 6, 9	Mounting Holes: The holes support Wall Mount brackets for system in
	vertical position.
2, 8	VESA Holes : The holes support VESA bracket to attach the iEP-703XE-020
	and iEP-703XE-025 to the rear of a compatible display.
3, 5, 7, 10	Front Cover screw Holes: The holes are used to secure the front cover.

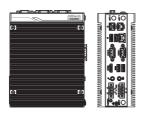
2.6 Position

The system should be placed in vertical or horizontal position.

 Positions of the iEP-7040E-020, iEP-7041E-020, iEP-7040-025 and iEP-7041E-025: vertical & horizontal



 Positions of the iEP-7040E-021, iEP-7041E-021, iEP-7040E-022, iEP-7041E-022, iEP-7040E-023, iEP-7041E-023, iEP-7040E-024 and iEP-7041E-024: only vertical



Chapter 3 Hardware Installation

This chapter helps you install or remove important components.

3.1 How to Install the Wi-Fi Module (2230) to the M.2 Key E Slot (Optional)

1. Locate the WiFi Module slot on the motherboard.



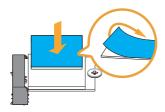
2. Carefully insert the WiFi Module into the slot at a 30-degree angle.



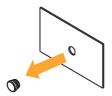
3. Tighten the screw to secure the WiFi Module to the motherboard.



4. Paste the thermal pad onto the WiFi Module. Then remove the membrane.



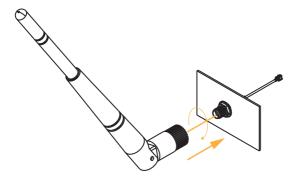
5. Remove the antenna rubber on the box cover.



Attach the SMA cable and washer to both sides of the cover, and secure them with the nut.



7. Install the Wifi antenna onto the SMA cable.

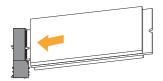


3.2 How to Install the 4G LTE/5G Module (3042/3052) to the M.2 Key B Slot (Optional)

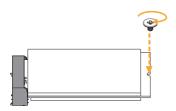
1. Locate the 4G LTE/5G Module slot on the motherboard.



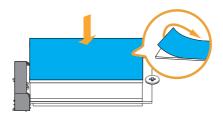
2. Carefully insert the 4G LTE/5G Module into the slot at a 30-degree angle.



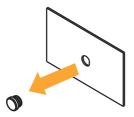
3. Tighten the screw to secure the 4G LTE/5G Module to the motherboard.



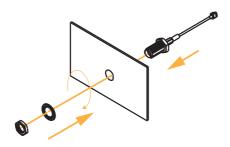
4. Paste the thermal pad onto the 4G LTE/5G Module. Then remove the membrane.



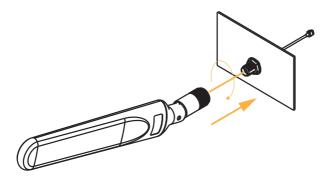
5. Remove the antenna rubber on the box cover.



6. Attach the SMA cable and washer to both sides of the cover, and secure them with the nut.



7. Install the 4G LTE/5G antenna onto the SMA cable.



3.3 How to Install the M.2 SSD (2280) to the M.2 Key M Socket

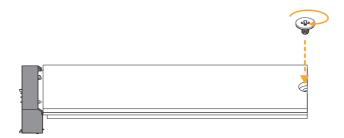
1. Locate the M.2 slot on the motherboard.



2. Carefully insert the M.2 SSD (Type 2280) into the slot at a 30-degree angle.



3. Tighten the screw to secure the M.2 SSD (Type 2280) to the motherboard.



3.4 How to Install the Memory Modules

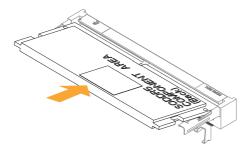


The iEP-7040E Series requires DDR5 SO-DIMM (1.1V). For dual channel configuration, you always need to install identical (the same brand, speed, size and chip-type) DDR5 SO-DIMM pairs

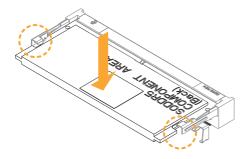


The SO-DIMM only fits in one correct orientation. It will cause permanent damage to the motherboard and the DIMM if you force the DIMM into the slot at incorrect orientation.

1. Carefully insert the SO-DIMM memory modules into the slot at a 30-degree angle..

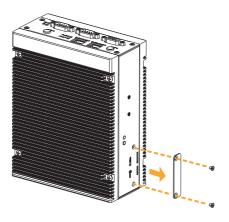


2. Push down until the modules snap into place.

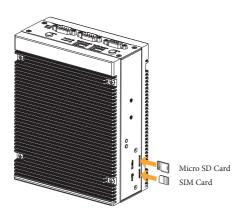


3.5 How to Install a Nano SIM Dard and Micro SD Card

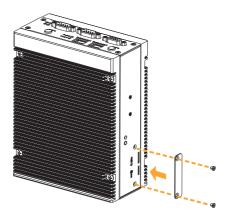
1. Release the screws on the iEP-7040E Series and remove the SIM/Micro SD Card slot cover.



2. With the gold contacts facing front, carefully insert the SIM Card or the SD Card into the designated slot until it clicks.

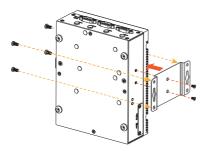


3. Place the cover back and secure it to the iEP-7040E Series with screws.

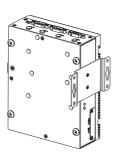


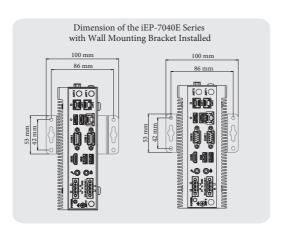
3.6 How to Install the Wall Mounting Bracket (Optional)

- Wall mounting: vertical
- 1. Attach the wall mounting brackets to the iEP-7040E Series and secure it with two screws. Then you can attach the iEP-7040E Series to the wall with four screws.

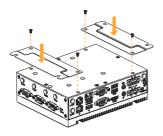


2. The wall mounting bracket is installed.



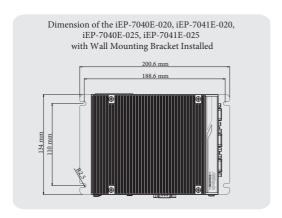


- Wall mounting: horizontal
- 1. Attach the wall mounting brackets to the iEP-7040E-020, iEP-7041E-020, iEP-7040E-025, iEP-7041E-025 and secure it with screws.



2. The wall mounting brackets are installed.



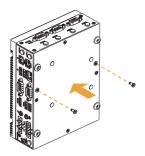




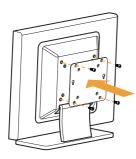
Wall Mounting Bracket is not provided by default. Please purchase it seperately if needed.

3.7 How to Install VESA Bracket (Optional) (for Basic/8DIO SKU)

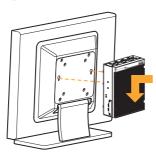
Attach the two screws to the base of the iEP-7040E-020, iEP-7041E-020, iEP-7040E-025, iEP-7041E-025.



2. Attach the VESA Bracket to the rear of a compatible display using the four screws.
*Choose mounting holes depending on the mounting hole pattern of your LCD screen (75 mm \times 75 mm or 100 mm \times 100 mm).



 Mount the iEP-7040E-020, iEP-7041E-020, iEP-7040E-025, iEP-7041E-025 by sliding it into place.

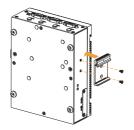


3.8 How to Install the Din Rail (Optional)

1. Attach the Din Rail Bracket to the iEP-7040E Series and secure it with screws.

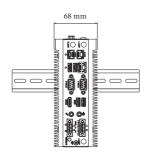


iEP-7040E-021, iEP-7041E-021, iEP-7040E-022, iEP-7041E-022, iEP-7040E-023, iEP-7041E-023, iEP-7040E-024, iEP-7041E-024.

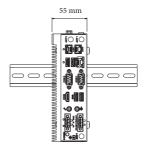


iEP-7040E-020, iEP-7041E-020, iEP-7040E-025, iEP-7041E-025

2. Then you can place the iEP-7040E Series to the Din Rail.



iEP-7040E-021, iEP-7041E-021, iEP-7040E-022, iEP-7041E-022, iEP-7040E-023, iEP-7041E-023, iEP-7040E-024, iEP-7041E-024,



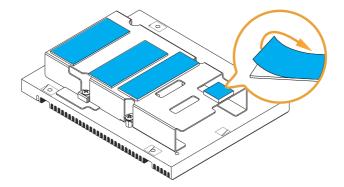
iEP-7040E-020, iEP-7041E-020, iEP-7040E-025, iEP-7041E-025



Din Rail Bracket is not provided by default. Please purchase it seperately if needed.

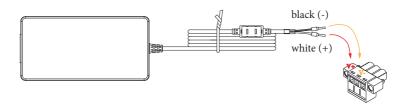
3.9 How to Remove the Membranes

Please note to remove the membranes from the heatsinks before reinstall the bottom case.

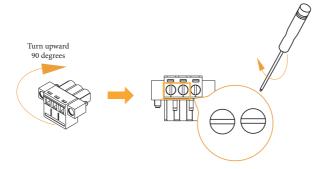


3.10 How to Install Phoenix Connector and the Adapter (Optional)

1. Insert white (+) cable of the adapter into the left port of the phoenix connector, and insert the black (-) cable into the middle port. Ensure the cables are inserted to the end.



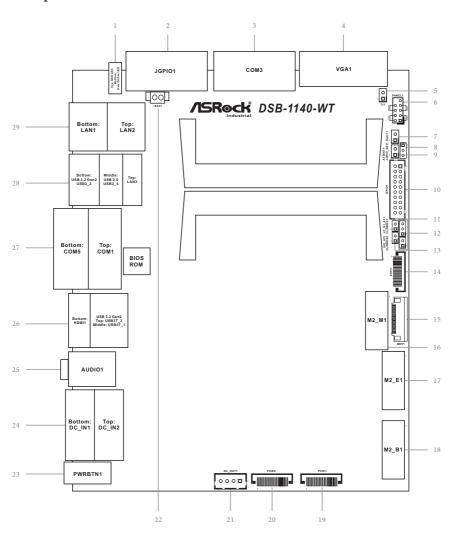
Tighten the left two screws from the top of the phoenix connector with a flathead screwdriver. Ensure the cables are inserted to the end and cannot be unplugged.



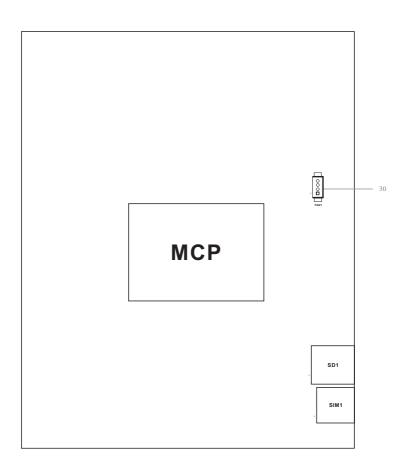
Chapter 4 Motherboard

4.1 Motherboard Layout

Top Side:



Rear Side:



- 1 : Top: HDD LED Bottom: User Define LED
- 2: Digital Input/Output Connector (JGPIO1)
- 3: COM Port (COM3) (RS232/422/485)*
- 4: D-Sub Port (VGA1)
- 5: Chassis Intrusion Headers (CI1)
- 6: System Panel Header (PANEL1)
- 7: DACC Jumper (DACC1)
- 8 : Digital Input/Output Default Value Setting (JGPIO_SET1)
- 9: ATTEST1
- 10: Digital Input/Output Connector (GPIO1)
- 11: ASRI internal G3 aging jumper (JP_G3_AT1)
- 12: Clear CMOS Headers (CLRMOS1, CLRMOS2)
- 13: ATX/AT Mode Jumper (SIO_AT1)
- 14: ESPI Header (ESPI1)
- 15: MIPI Header (MIPI1)
- 16: M.2 Key-M Socket (M2_M1)
- 17: M.2 Key-E Socket (M2_E1)
- 18: M.2 Key-B Socket (M2_B1)
- 19: PCIE Connector (PCIE1)
- 20: PCIE Connector (PCIE2)
- 21: Power Connector (DC_OUT1) (12V/GND)
- 22: Battery Connector (BAT1)
- 23: Power Button (PWRBTN1)
- 24: DC Input Connectors (DC_IN1_2)

Top: DC_IN2

Bottom: DC_IN1

25 : Audio Jacks Top : Green - Line Out

Bottom: Pink - Mic In

26: USB 3.2 Gen2 Ports

Top: USB3T_2 Middle: USB3T_1

Bottom: HDMI Port (HDMI1)

27: COM Ports

Top: COM1 (RS232/422/485)*

Bottom: COM5 (RS232/422/485)*

28: Top: RJ45 LAN Port (LAN3)

Middle: USB 2.0 Port (USB3_4)

Bottom: USB 3.2 Gen2 Port (USB3_3)

29: RJ45 LAN Ports

Top: LAN2

Bottom: LAN1

Backside:

30: Fan Connector (FAN1)

4.2 Jumpers Setup

The illustration shows how jumpers are setup. When the jumper cap is placed on pins, the jumper is "Short." If no jumper cap is placed on pins, the jumper is "Open." The illustration shows a 3-pin jumper whose pin1 and pin2 are "Short" when a jumper cap is placed on these 2 pins.







Chassis Intrusion Header

(2-pin CI1)

(see p. 50, No. 5)

Setting	Description
Close	Active Case Open
Open	Normal (Default)

This motherboard supports CASE OPEN detection feature that detects if the chassis cover has been removed. This feature requires a chassis with chassis intrusion detection design.

DACC Jumper

(2-pin DACC1)

(see p. 50, No. 7)

0	2
	1

Setting	Description
Open	No ACC (Default)
Short	ACC

Auto clear CMOS when system boot improperly.

Digital Input/Output Default Value Setting

(3-pin JGPIO_SET1)

(see p. 50, No. 8)



Setting	Description
1-2	Pull-High (Default)
2-3	Pull-Low

ATTEST1

(2-pin ATTEST1)

(see p. 50, No. 9)

(see p. 50, No. 9)

For internal test



ASRI internal G3 aging jumper
(2-pin JP_G3_AT1)
(see p. 50, No. 11)



Pin	Description
1	G3_AT_GPIO#
2	GND



Setting	Description
1-2	Normal (Default)
2-3	Clear CMOS

Note: CLRMOS1 allows you to clear the data in CMOS. To clear and reset the system parameters to default setup, please turn off the computer and unplug the power cord from the power supply. After waiting for 15 seconds, use a jumper cap to short pin2 and pin3 on CLRMOS1 for 5 seconds. However, please do not clear the CMOS right after you update the BIOS. If you need to clear the CMOS when you just finish updating the BIOS, you must boot up the system first, and then shut it down before you do the clear-CMOS action. Please be noted that the date, time and user default profile will be cleared only if the CMOS battery is removed.

(2-pin CLRMOS2) (see p. 50, No. 12)



Setting	Description
Open	Normal (Default)
Short	Auto Clear CMOS (Power Off)

Note: CLRMOS2 allows you to clear the data in CMOS automatically when AC power on. The data in CMOS includes system setup information such as system password, date, time, and system setup parameters. To clear and reset the system parameters to default setup, please turn off the computer and unplug the power cord, and then use a jumper cap to short the pins on CLRMOS2.

ATX/AT Mode Jumper (2-pin SIO_AT1)

(see p. 50, No. 13)



Setting	Description
Open	ATX Mode (Default)
Short	AT Mode

The header provides auto boot function when AC power is on. If you need the function, short SIO_AT1 pin 1 and pin 2.

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4.3 Onboard Headers and Connectors



Onboard headers and connectors are NOT jumpers. Do NOT place jumper caps over these headers and connectors. Placing jumper caps over the headers and connectors will cause permanent damage to the motherboard!

System Panel Header

(9-pin PANEL1)

(see p. 50, No. 6)



Pin	Signal Name	Signal Name	Pin
1	HDLED+	PLED+	2
3	HDLED-	PLED-	4
5	GND	PWRBTN#	6
7	RESET#	GND	8
9	GND		10

This header accommodates several system front panel functions.



Connect the power switch, reset switch and system status indicator on the chassis to this header according to the pin assignments below. Note the positive and negative pins before connecting the cables.

PWRBTN (Power Switch):

Connect to the power switch on the chassis front panel. You may configure the way to turn off your system using the power switch.

RESET (Reset Switch):

Connect to the reset switch on the chassis front panel. Press the reset switch to restart the computer if the computer freezes and fails to perform a normal restart.

PLED (System Power LED):

Connect to the power status indicator on the chassis front panel. The LED is on when the system is operating. The LED keeps blinking when the sys-tem is in S1 sleep state. The LED is off when the system is in S3/S4 sleep state or powered off (S5).

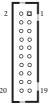
HDLED (Hard Drive Activity LED):

Connect to the hard drive activity LED on the chassis front panel. The LED is on when the hard drive is reading or writing data.

The front panel design may differ by chassis. A front panel module mainly consists of power switch, reset switch, power LED, hard drive activity LED, speaker and etc. When connecting your chassis front panel module to this header, make sure the wire assignments and the pin assign-ments are matched correctly.

Digital Input/Output Connector (20-pin GPIO1)

(see p. 50, No. 10)



Pin	Signal Name	Signal Name	Pin
	GND	GND	
1		GND	2
3	MCU_SPI0_	GPP E7	4
	MOSI	GII_L/	T .
5	MCU_SPI0_	GPP E5	6
3	MISO	GFF_E3	0
7	MCU_SPI0_CLK	GPP_E4	8
9	MCU_SPI0_SS	GPP_D3	10
11	DSC_DIO_GP2	GPP_C23	12
13	DSC_DIO_GP1	GPP_C22	14
15	ICE_CLK	GPP_B23	16
17	ICE_DAT	GPP_B20	18
19	+3V	+3V	20

ESPI Header

(20-pin ESPI1)

(see p. 50, No. 14)

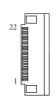


Pin	Signal Name
1	GND
2	C_ESPI_CLK
3	GND
4	C_ESPI_CS#
5	DEBUG_RESET
6	GND
7	+3V
8	GND
9	SMB_CLK_MAIN
10	SMB_DATA_MAIN
11	C_ESPI_IO0
12	C_ESPI_IO1
13	C_ESPI_IO2
14	C_ESPI_IO3
15	GND
16	+3VSB
17	N/A
18	N/A
19	C_ESPI_ALERT#
20	GND

MIPI Header

(22-pin MIPI)

(see p. 50, No. 15)



Pin	Signal Name
1	+3V
2	I2C0_SDA
3	I2C0_SCL
4	GND
5	N/A
6	N/A
7	GND
8	CSI_E_D3_DP
9	CSI_E_D3_DN
10	GND
11	CSI_E_D2_DP
12	CSI_E_D2_DN
13	GND
14	CSI_E_CK_DP
15	CSI_E_CK_DN
16	GND
17	CSI_E_D1_DP
18	CSI_E_D1_DN
19	GND
20	CSI_E_D0_DP
21	CSI_E_D0_DN
22	GND

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PCIE Connectors

(20-pin PCIE1)

(see p. 50, No. 19)

(20-pin PCIE2)

(see p. 50, No. 20)



Pin	Signal Name
1	+12V
2	+12V
3	PLT_RST#
4	GND
5	CLKP
6	CLKN
7	GND
8	PCIE_TXP
9	PCIE_TXN
10	GND
11	PCIE_RXP
12	PCIE_RXN
13	GND
14	CLKREQ#
15	GND
16	+12V
17	+12V
18	+12V
19	+12V
20	+12V

Power Connectors (12V/GND)

(4-pin DC_OUT1)

(see p. 50, No. 21)



Pin	Signal Name
1	+12VSB
2	GND
3	GND
4	+12VSB

Battery Connector

(2-pin BAT1)

(see p. 50, No. 22)



Pin	Signal Name	
1	+BAT	
2	GND	

Backside:

Fan Connector

(4-pin FAN1)

(see p. 51, No. 30)



Pin	Signal Name	
1	GND	
2	+5V	
3	FAN_SPEED	
4	FAN_SPEED_CONTROL	

4.4 Expansion Slots (M.2 Sockets)

There are three M.2 sockets on the motherboard.

M.2 Key-M Socket (M2_M1)

(see p. 50, No. 16)

M.2 Key M Socket (2280)(PCIe Gen4)

Pin	Signal Name	Signal Name	Pin
1	GND	+3.3V	2
3	GND	+3.3V	4
5	PERn3	NA	6
7	PERp3	NA	8
9	GND	SATA_LED	10
11	PETn3	+3.3V	12
13	PETp3	+3.3V	14
15	GND	+3.3V	16
17	PERn2	+3.3V	18
19	PERp2	NA	20
21	GND	NA	22
23	PETn2	NA	24
25	PETp2	NA	26
27	GND	NA	28
29	PERn1	NA	30
31	PERp1	NA	32
33	GND	NA	34
35	PETn1	NA	36
37	PETp1	NA	38
39	GND	SMB_CLK	40
41	PERn0	SMB_DATA	42
43	PERp0	NA	44
45	GND	NA	46
47	PETn0	NA	48
49	PETP0	PERST#	50
51	GND	CLKREQ#	52
53	PEFCLKn	NA	54
55	PEFCLKp	NA	56
57	GND	NA	58
67	NA	NA	68
69	PEDET	+3.3V	70
71	GND	+3.3V	72
73	GND	+3.3V	74
75	GND		

M.2 Key-E Socket (M2_E1):

(see p. 50, No.17)

M.2 Key E Socket (2230/2260)(CNVio/CNVio2/PCIe Gen3/USB 2.0 mode)

- Supports Wifi/BT module

1	GND	+3.3V	2
3	USB_D+	+3.3V	4
5	USB_D-	NA	6
7	GND	NA	8
9	CNV_WGR_D1-	CNV_RF_RESET	10
11	CNV_WGR_D1+	NA	12
13	GND	MODEM_CLKREQ	14
15	CNV_WGR_D0-	NA	16
17	CNV_WGR_D0+	GND	18
19	GND	NA	20
21	CNV_WGR_CLK-	CNV_BRI_RSP	22
23	CNV_WGR_CLK+		1
			Т
		CNV_BGI_DT	32
33	GND	CNV_RGI_RSP	34
35	PETp	CNV_BRI_DT	36
37	PETn	NA	38
39	GND	NA	40
41	PERp	NA	42
43	PERn	NA	44
45	GND	NA	46
47	PEFCLKp	NA	48
49	PEFCLKn	SUSCLK	50
51	GND	PERSTO#	52
53	CLKREQ#	W_DISABLE1#	54
55	NA	W_DISABLE2#	56
57	GND	SMB_DATA	58
59	CNV_WT_D1-	SMB_CLK	60
61	CNV_WT_D1+	NA	62
63	GND	NA	64
65	CNV_WT_D0-	NA	66
67	CNV_WT_D0+	NA	68
69	GND	NA	70
71	CNV_WT_CLK-	+3.3V	72
73	CNV_WT_CLK+	+3.3V	74
75	GND		\top
			-

M.2 Key-B Socket (M2_B1) (see p. 50, No. 18)

M.2 Key B Socket (3042/3052) (PCIe Gen3/USB 3.2 mode)

- Supports 4G LTE/5G module

Pin	Signal Name	Signal Name	Pin
1	NA	+3.3V	2
3	GND	+3.3V	-4
5	GND	FuLL_Card_Power_off	6
7	USB_D+	W_DISABLE	8
9	USB_D-	WWAN_LED#	10
11	GND		
		NA	20
21	GND	NA	22
23	NA	NA	24
25	NA	NA	26
27	GND	NA	28
29	USB3_RX-	UIM_RESET	30
31	USB3_RX+	UIM_CLK	32
33	GND	UIM_DATA	34
35	USB3_TX-	UIM_PWR	36
37	USB3_TX+	NA	38
39	GND	NA	40
41	PERn0	NA NA	42
43	PERp0	NA	44
45	GND	NA	46
47	PETn0	NA	48
49	PETP0	PERST#	50
51	GND	CLKREQ#	52
53	PEFCLKn	NA	54
55	PEFCLKp	NA	56
57	GND	NA	58
59	NA	NA	60
61	NA	NA	62
63	NA	NA	64
65	NA	NA	66
67	NA	NA	68
69	PEDET	+3.3V	70
71	GND	+3.3V	72
73	GND	+3.3V	74
75	NA		

Chapter 5 UEFI Setup Utility

5.1 Introduction

ASRock Industrial UEFI (Unified Extensible Firmware Interface) is a BIOS utility which offers tweak-friendly options in an advanced viewing interface. The UEFI system works with a USB mouse and offers users a faster, sleeker experience.

This BIOS utility can perform the Power-On Self-Test (POST) during system startup, record hardware parameters of the system, load operating system, and so on. The battery on the motherboard supplies the power needed to the CMOS when the system power is turned off, and the values configured in the UEFI utility are kept in the CMOS.

Please note that inadequate BIOS settings may cause system instability, mulfunction or boot failure. We strongly recommend that you do not alter the UEFI default configurations or change the settings only with the assistance of a trained service person.

If the system becomes unstable or fails to boot after you change the setting, try to clear the CMOS values and reset the board to default values. See your motherboard manual for instructions.

5.1.1 Entering BIOS Setup

You may run the UEFI Setup Utility by pressing <F2> or <Delete> right after you power on the computer; otherwise, the Power-On-Self-Test (POST) will continue with its test routines. If you wish to enter the UEFI Setup Utility after POST, restart the system by pressing <Ctl> + <Alt> + <Delete>, or by pressing the reset button on the system chassis. You may also restart by turning the system off and then back on.

This setup guide explains how to use the UEFI Setup Utility to configure all the supported system. The screenshots in this manual are for reference only. UEFI Settings and options may vary owing to different BIOS release versions or CPU installed. Please refer to the actual BIOS version of the motherboard you purchased for detailed screens, settings and options.

5.1.2 UEFI Menu Bar

The top of the screen has a menu bar with the following selections:

Main	For setting system time/date information
Advanced	For advanced system configurations
H/W Monitor	Displays current hardware status
Security	For security settings
Boot	For configuring boot settings and boot priority
Exit	Exit the current screen or the UEFI Setup Utility



Because the UEFI software is constantly being updated, the following UEFI setup screens and descriptions for reference purpose only, and may vary from the latest BIOS and do not exactly match what you see on your screen.

5.1.3 Navigation Keys

Use < \longrightarrow key or < \longrightarrow key to choose among the selections on the menu bar, and use

< \uparrow > key or < \downarrow > key to move the cursor up or down to select items, then press <Enter> to get into the sub screen. You can also use the mouse to click your required item.

Please check the following table for the descriptions of each navigation key.

Navigation Key(s)	Description
+ / -	To change option for the selected items
<tab></tab>	Switch to next function
<pgup></pgup>	Go to the previous page
<pgdn></pgdn>	Go to the next page
<home></home>	Go to the top of the screen
<end></end>	Go to the bottom of the screen
<f1></f1>	To display the General Help Screen
<f7></f7>	Discard changes and exit the SETUP UTILITY
<f9></f9>	Load optimal default values for all the settings
<f10></f10>	Save changes and exit the SETUP UTILITY
<f12></f12>	Print screen
<esc></esc>	Jump to the Exit Screen or exit the current screen

5.2 Main Screen

When you enter the UEFI SETUP UTILITY, the Main screen will appear and display the system overview.





Because the UEFI software is constantly being updated, the following UEFI setup screens and descriptions are for reference purpose only, and they may not exactly match what you see on your screen. Options may also vary depending on the features of your motherboard.

5.3 Advanced Screen

In this section, you may set the configurations for the following items: CPU Configuration, Chipset Configuration, Intel(R) Time Coordinated Computing, Storage Configuration, Super IO Configuration, AMT Configuration, ACPI Configuration, USB Configuration, and Trusted Computing.





Setting wrong values in this section may cause the system to malfunction.

Instant Flash

Instant Flash is a UEFI flash utility embedded in Flash ROM. This convenient UEFI update tool allows you to update system UEFI without entering operating systems first like MS-DOS or Windows*. Just launch this tool and save the new UEFI file to your USB flash drive, floppy disk or hard drive, and then you can update your UEFI in only a few clicks without preparing an additional floppy diskette or other complicated flash utility. Please be noted that the USB flash drive or hard drive must use FAT32/16/12 file system. If you execute Instant Flash utility, the utility will show the UEFI files and their respective information. Select the proper UEFI file to update your UEFI, and reboot your system after UEFI update process completes.

5.3.1 CPU Configuration



Intel Hyper Threading Technology

Intel Hyper Threading Technology allows multiple threads to run on each core, so that the overall performance on threaded software is improved.

Configuration options: [Enabled] [Disabled]

Active Processor P-Cores

This allows you to select the number of cores to enable in each processor package.

Active Processor F-Cores

This allows you to select the number of E-Cores to enable in each processor package.

NOTE: Number of P-Cores and E-Cores are looked at together. When both are {0,0},

Pcode will enable all cores.

CPU C States Support

This allows you to enable CPU C States Support for power saving. It is recommended to keep C3, C6 and C7 all enabled for better power saving.

Configuration options: [Enabled] [Disabled]

Enhanced Halt State (C1E)

The option allows you to enable Enhanced Halt State (C1E) for lower power consumption.

Package C State Support

The option allows you to enable CPU, PCIe, Memory, Graphics C State Support for power saving.

CFG Lock

The option allows you to enable or disable the CFG Lock.

Configuration options: [Enabled] [Disabled]

Intel Virtualization Technology

When this option is set to [Enabled], a VMM (Virtual Machine Architecture) can utilize the additional hardware capabilities provided by Vanderpool Technology. This option will be hidden if the installed CPU does not support Intel Virtualization Technology.

Configuration options: [Enabled] [Disabled]

Intel SpeedStep Technology

Intel SpeedStep technology allows processors to switch between multiple frequencies and voltage points for better power saving and heat dissipation. CPU turbo ratio can be fixed when Intel SpeedStep Technology is set to [Disabled] and Intel Turbo Boost Technology is set to [Enabled].

If you install Windows* 10 and want to enable this function, please set this item to [Enabled]. This item will be hidden if the current CPU does not support Intel SpeedStep technology.

Configuration options: [Enabled] [Disabled]



Please note that enabling this function may reduce CPU voltage and lead to system stability or compatibility issues with some power supplies. Please set this item to [Disabled] if above issues occur.

Intel Turbo Boost Technology

Intel Turbo Boost Technology enables the processor to run above its base operating frequency when the operating system requests the highest performance state. The

default value is [Enabled].

CPU Thermal Throttling

CPU Thermal Throttling allows you to enable CPU internal thermal control mechanisms to keep the CPU from overheating.

Configuration options: [Enabled] [Disabled]

Intel Trusted Execution Technology

This item allows you to enable or disable the Intel Trusted Execution Technology function.

5.3.2 Chipset Configuration



VT-d

Intel® Virtualization Technology for Directed I/O helps your virtual machine monitor better utilize hardware by improving application compatibility and reliability, and providing additional levels of manageability, security, isolation, and I/O performance.

Configuration options: [Enabled] [Disabled]

Share Memory

Share memory allows you to configure the size of memory that is allocated to the integrated graphics processor when the system boots up.

Configuration options: [Auto] [32M] [64M] [128M] [256M] [512M] Options vary depending on the memory you use on your motherboard.

Render Standby

Power down the render unit when the GPU is idle for lower power consumption.

Onboard LAN1

This allows you to enable or disable the Onboard LAN1 feature.

Onboard LAN2

This allows you to enable or disable the Onboard LAN2 feature.

Onboard LAN3

This allows you to enable or disable the Onboard LAN3 feature.

Onboard HD Audio

Select [Auto], [Enabled] or [Disabled] for the onboard HD Audio feature. If you select [Auto], the onboard HD Audio will be disabled when PCI Sound Card is plugged.

Power Button Control

The item enables or disables Power Button Function.

Restore on AC/Power Loss

Select the power state after a power failure. If [Power Off] is selected, the power will remain off when the power recovers. If [Power On] is selected, the system will start to boot up when the power recovers.

5.3.3 Intel(R) Time Coordinated Computing



#AC Split Lock

Enable or Disable Alignment Check Exception (#AC). When enabled, this will assert an #AC when any atomic operation has an operand that crisses two cache lines.

#GP Fault UC Lock

Enable or Disable GP Fault Exception (GP#). When enabled, this will assert an GP# when encountering a Lock to un-cacheable memory before the bus is locked.

Software SRAM

Enable or Disable Software SRAM. Enable will allocate 1 way of LLC; if Cache Configuration subregion is available, it will allocate based on the subregion.

Data Streams Optimizer

Enable or Disable Data Streams Optimizer (DSO). Enable will utilize DSO Subregion to tune system. DSO settings supercede Intel(R) TCC Mode settings that overlap between the two.

Error Log

Enable or Disable Error Log. Enable will record errors related to Intel(R) TCC and save them to memory.

Interl (R) TCC Authenticatiion Menu

Press Enter to configure Intel(R) TCC Authentication Menu options.

Interl (R) TCC Mode

The item enables or disables Intel(R) TCC Mode. When enabled, this will modify system settings to improve real-time performance. The full list of settings and their current state are displayed below when Intel(R) TCC mode is enabled.

L2 QOS Enumeration

Enable or Disable L2 QOS Enumerate. When Enable CPUID Enumeration for L2 QOS gets enabled.

IO Fabric Low Latency

The item enables or disables IO Fabric Low Latency. This will turn off some power management in the PCH IO fabrics. This option provides the most aggressive IO Fabric performance setting. S3 state is NOT supported.

GT CLOS

The item enables or disables Graphics Technology(GT) Class of Service. Enable will reduce Gfx LLC allocation to minimize impact of Gfx workload on LLC.

OPIO Recentering

Enable or Disable Opio Recentering to improve Pcie latency.

5.3.4 Storage Configuration



VMD Configuration

This item allows you to enable or disable the Intel VMD support function.

SATA Controller(s)

The option allows you to enable or disable the SATA controllers.

Configuration options: [Enabled] [Disabled]

SATA Mode Selection

AHCI supports new features that improve performance.

Configuration option: [AHCI]



AHCI (Advanced Host Controller Interface) supports NCQ and other new features that will improve SATA disk performance but IDE mode does not have these advantages.

Hybrid Storage Detection and Configuration Mode

The option allows you to select Hybrid Storage Detection and Configuration Mode.

Configuration options: [Dynamic Configuration for Hybrid Storage Enable] [Disabled]

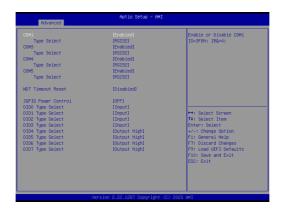
SATA Aggressive Link Power Management

SATA Aggressive Link Power Management allows SATA devices to enter a low power state during periods of inactivity to save power. It is supported only by AHCI mode.

Hard Disk S.M.A.R.T.

S.M.A.R.T stands for Self-Monitoring, Analysis, and Reporting Technology. It is a monitoring system for computer hard disk drives to detect and report on various indicators of reliability.

5.3.5 Super IO Configuration



COM1

Use this to set parameters of COM1.

Type Select

Use this to select COM1 port type: [RS232], [RS422] or [RS485].

COM₃

Use this to set parameters of COM3.

Type Select

Use this to select COM3 port type: [RS232], [RS422] or [RS485].

COM4

Use this to set parameters of COM4.

Type Select

Use this to select COM4 port type: [RS232], [RS422] or [RS485].

COM₅

Use this to set parameters of COM5.

Type Select

Use this to select COM5 port type: [RS232], [RS422] or [RS485].

WDT Timeout Reset

Use this to set the Watch Dog Timer.

JGPIO Power Control

Use this to select JGPIO Power: [OFF], [+3V] or [+5V]

DID0 Type Select

Use this to set DIO Type: [Input].

DID1 Type Select

Use this to set DIO Type: [Input].

DID2 Type Select

Use this to set DIO Type: [Input].

DID3 Type Select

Use this to set DIO Type: [Input].

DID4 Type Select

Use this to set DIO Type: [Input].

DID5 Type Select

Use this to set DIO Type: [Input].

DID6 Type Select

Use this to set DIO Type: [Input].

DID7 Type Select

Use this to set DIO Type: [Input].

Pin Location and Corresponding Signal

DIO	Function
DIO0	SIO GPIO70
DIO1	SIO GPIO71
DIO2	SIO GPIO72
DIO3	SIO GPIO73
DIO4	SIO GPIO74
DIO5	SIO GPIO75
DIO6	SIO GPIO76
DIO7	SIO GPIO77

5.3.6 AMT Configuration



USB Provisioning of AMT

Use this to enable or disable AMT USB Provisioning. The default is [Disabled].

MAC Pass Through

The option enables or disables MAC Pass Through function.

Dynamic Lan Switch

This allows switching AMT support from Integrated LAN to Discrete LAN.

Activate Remote Assistance Process

Trigger CIRA boot. The default is [Disabled].

Un-Configure ME

Un-Configure ME without password. The default is [Disabled].

ASF Configuration

The option allows you to configure Alert Standard Format parameters.

Secure Erase Configuration

Secure Erase configuration menu.

One Click Recovery(OCR) Configuration

Configuration setting for One Click Recovery. This allows access for AMT to boot a recovery OS application.

Remote Platform Erase Configuration

Remote Platform Erase configuration menu.

MEBx

This Formset contains forms for configuring MEBx.

5.3.7 ACPI Configuration



Suspend to RAM

Suspend to RAM allows you to select [Disabled] for ACPI suspend type S1. It is recommended to select [Auto] for ACPI S3 power saving.

Configuration options: [Auto] [Disabled]

Onboard LAN Power On

Use this item to enable or disable onboard LAN to turn on the system from the power-soft-off mode.

RTC Alarm Power On

RTC Alarm Power On allows the system to be waked up by the real time clock alarm. Set it to By OS to let it be handled by your operating system.

5.3.8 USB Configuration



USB Power Control

Use this option to control USB power.

M.2 Key_B Function

The item enables or disables M.2 Key_B USB function.

5.3.9 Trusted Computing



Security Device Support

Security Device Support allows you to enable or disable BIOS support for security device. O.S. will not show Security Device. TCG EFI protocol and INT1A interface will not be available.

Configuration options: [Enabled] [Disabled]

Active PCR banks

This item displays active PCR Banks.

Available PCR Banks

This item displays available PCR Banks.

SHA256 PCR Bank

SHA256 PCR Bank allows you to enable or disable SHA256 PCR Bank.

Configuration options: [Enabled] [Disabled]

Pending Operation

Pending Operation allows you to schedule an Operation for the Security Device.

NOTE: Your computer will reboot during restart in order to change State of the Device.

Configuration options: [None] [TPM Clear]

Platform Hierarchy

This item allows you to enable or disable Platform Hierarchy.

English

Storage Hierarchy

This item allows you to enable or disable Storage Hierarchy.

Configuration options: [Enabled] [Disabled]

Endorsement Hierarchy

This item allows you to enable or disable Endorsement Hierarchy.

Configuration options: [Enabled] [Disabled]

Physical Presence Spec Version

Select this item to tell OS to support PPI spec version 1.2 or 1.3. Please note that some HCK tests might not support version 1.3.

Configuration options: [1.2] [1.3]

TPM 2.0 InterfaceType

This item allows you to view the Communication Interface to TPM 2.0 Device: CRB or TIS.

PH Randomization

The item enables or disables Platform Hierarchy randomization.

Device Select

This item allows you to select the TPM device to be supported.

[TPM 1.2] restricts support to TPM 1.2 devices.

[TPM 2.0] restricts support to TPM 2.0 devices.

[Auto] supports both TPM 1.2 and TPM 2.0 devices with the default set to TPM 2.0 devices. If TPM 2.0 devices are not found, TPM 1.2 devices will be enumerated.

Onboard TPM

The option enables or disables Intel PTT in ME. Disable this option to use discrete TPM Module.

5.4 Hardware Health Event Monitoring Screen

In this section, it allows you to monitor the status of the hardware on your system, including the parameters of the CPU temperature, motherboard temperature, fan speed, and the critical voltage.



FAN1 Setting

This allows you to set FAN1's speed. Configuration options: [Full On], and [Automatic Mode]. The default value is [Full On].

5.5 Security Screen

In this section, you may set, change or clear the supervisor/user password for the system.



Supervisor Password

Set or change the password for the administrator account. Only the administrator has the authority to change the settings in the UEFI Setup Utility. Leave it blank and press enter to remove the password.

User Password

Set or change the password for the user account. Users are unable to change the settings in the UEFI Setup Utility. Leave it blank and press enter to remove the password.

Secure Boot

Press [Enter] to configure the Secure Boot Settings. The feature protects the system from unauthorized access and malwares during POST. Secure Boot is supported on Window 8 / Ubuntu 12.04 / Fedora 19 and later.

5.6 Boot Screen

In this section, it will display the available devices on your system for you to configure the boot settings and the boot priority.



Boot From Onboard LAN

The item allows the system to be woke up by the onboard LAN.

Configuration options: [Enabled] [Disabled]

Setup Prompt Timeout

The item allows you to configure the number of seconds to wait for the UEFI setup utility. 65535(0XFFFF) means indefinite waiting.

Configuration options: [1] - [65535]

Bootup Num-Lock

The item allows you to select whether Num Lock should be turned on or off when the system boots up.

Configuration options: [On] [Off]

Full Screen Logo

[Enabled] Select this item to display the boot logo.

[Disabled] Select this item to show normal POST messages.

5.7 Exit Screen



Save Changes and Exit

When you select this option, the following message "Save configuration changes and exit setup?" will pop out. Select [Yes] to save the changes and exit the UEFI SETUP UTILITY.

Discard Changes and Exit

When you select this option, the following message "Discard changes and exit setup?" will pop out. Select [Yes] to exit the UEFI SETUP UTILITY without saving any changes.

Discard Changes

When you select this option, the following message "Discard changes?" will pop out. Select [Yes] to discard all the changes.

Load UEFI Defaults

The item allows you to load UEFI default values for all options. The F9 key can be used for this operation.

Launch EFI Shell from filesystem device

The item allows you to copy shellx64.efi to the root directory to launch EFI Shell.